

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE60P55K uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge .This device is well suited for high current load applications.

General Features

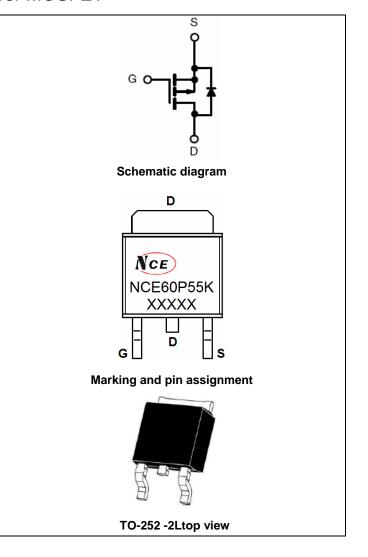
- V_{DS} =-60V, I_{D} =-55A $R_{DS(ON)}$ <28m Ω @ V_{GS} =-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- High side switch for full bridge converter
- DC/DC converter for LCD display

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P55K	NCE60P55K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	-55	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-24.8	А
Pulsed Drain Current	I _{DM}	-220	А
Maximum Power Dissipation	P _D	110	W
Derating factor		0.73	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	273	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.36	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=-250\mu A$	-2	-2.6	-3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	23	28	mΩ
Gate resistance	R _G	F=1.0MHz	-	10.0	-	Ω
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	-	25	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	3016.8	-	PF
Output Capacitance	Coss	V_{DS} =-30V, V_{GS} =0V, F=1.0MHz	-	180	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIMZ	-	126	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	t _r	V_{DD} =-30V, R_L =1.5 Ω ,	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{G} =3 Ω	-	38	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Qg	V 20 L 20 A	-	49.8		nC
Gate-Source Charge	Q _{gs}	V_{DS} =-30, I_{D} =-20A,	-	10.6		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	13.6		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-55	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =- 20A	-	47		nS
Reverse Recovery Charge	Qrr	$di/dt = -100A/\mu s^{(Note3)}$	-	53		nC

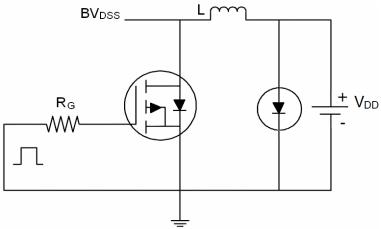
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: $Tj=25^{\circ}C$, $V_{DD}=-20V$, $V_{G}=-10V$,L=0.5mH, $Rg=25\Omega$

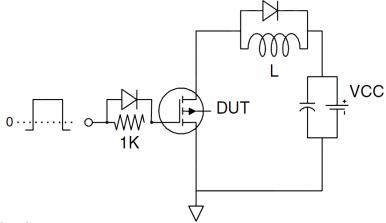


Test Circuit

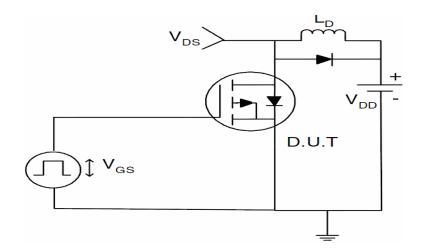
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

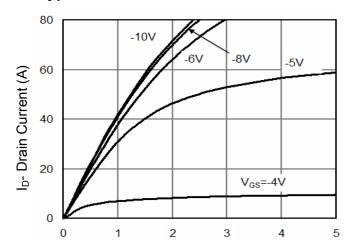


3) Switch Time Test Circuit

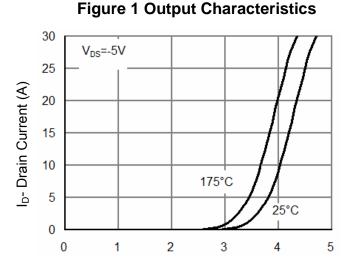




Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

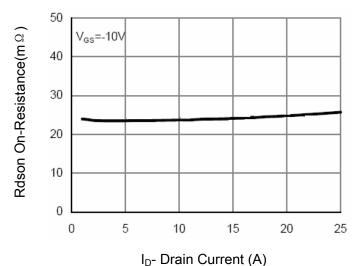


Figure 3 Rdson- Drain Current

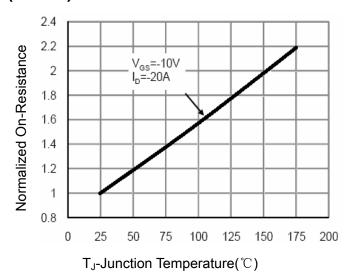
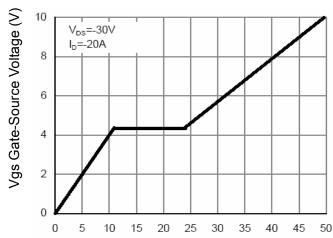


Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge

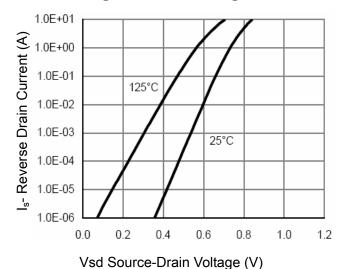


Figure 6 Source- Drain Diode Forward



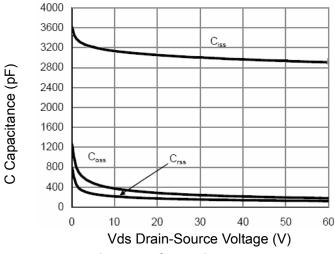
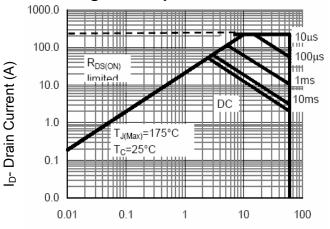


Figure 7 Capacitance vs Vds



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

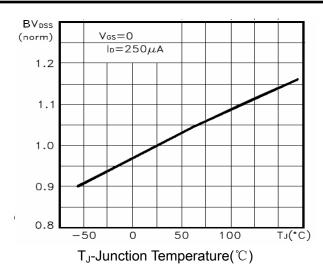


Figure 9 BV_{DSS} vs Junction Temperature

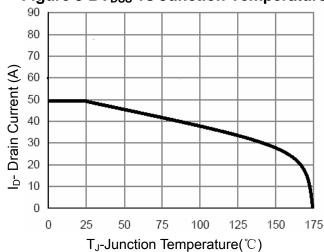


Figure 10 ID Current De-rating

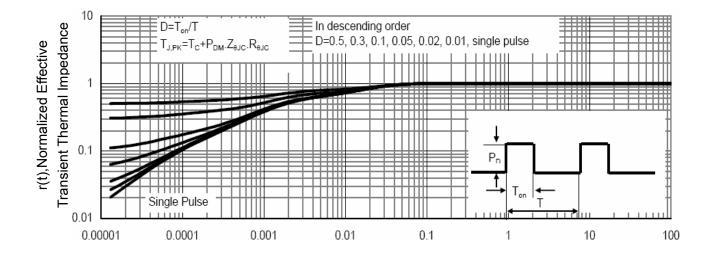
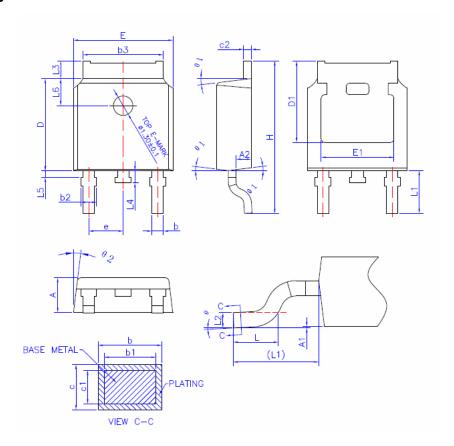


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



TO-252 Package Information



COMMON DIMENSIONS (UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX	
Α	2.20	2.30	2.38	
A1	0	_	0.10	
A2	0,90	1.01	1.10	
b	0.72	_	0.85	
b1	0.71	0.76	0.81	
b2	0,72	_	0.90	
b3	5,13	5,33	5.46	
С	0.47	_	0.60	
c1	0.46	0.51	0.56	
c2	0,47	_	0.60	
D	6,00	6.10	6.20	
D1	5.25	_		
E	6.50	6.60	6.70	
E1	4,70	_		
е	2,186	2,286	2,386	
Н	9.80	10.10	10.40	
L	1.40	1.50	1.70	
L1	2,90 REF			
L2	0,508 BSC			
L3	0.90	_	1.25	
L4	0.60	0.80	1.00	
L5	0,15	_	0,75	
L6	1.80 REF			
θ	0°	_	8°	
θ1	5°	7°	9°	
θ2	5°	7°	9°	

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NCE60P55K

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